



Adherence grade

Solvent type	Product name	Polymer component (%)	Solvent	Mw	Acid Value of polymer (mgKOH/g)	T _g (°C)	Doublebond equivalent (g/mol)	Feature
		OAP-5000	50	Butyl acetate	15,000	-	70	2,000
	MAP-4050	40	PGMEA /PGME	30,000	90	31	10,000	<ul style="list-style-type: none"> • Good adhesion to glass, metal, inorganic film • Good developability and flexibility • Improve adhesion of pressure sensitive adhesive
	MAP-7000	32	PGMEA /PGME	100,000	60	78	1,000	<ul style="list-style-type: none"> • Good adhesion to glass, metal, inorganic film • Good developability, chemical resistance, heat resistance • Good tack-free property before curing
Non-solvent type	Product name	Polymer component (%)	Diluent type	Mw	Acid Value of polymer (mgKOH/g)	T _g (°C)	Doublebond equivalent (g/mol)	Feature
	OAP-2531	35	IBXA /4-HBA	20,000	-	80	4,000	<ul style="list-style-type: none"> • Good adhesion to glass, metal, inorganic film • Good tack-free property after curing
	MAP-2801	28	Acrylic monomer	100,000	12	21	15,000	<ul style="list-style-type: none"> • Good adhesion to glass, metal, inorganic film • Good adhesion to COP, untreated PET, PI, LCP • Flexible after curing

High heat resistance grade

Solvent type	Product name	Polymer component (%)	Solvent	Mw	Acid Value of polymer (mgKOH/g)	T _g (°C)	Doublebond equivalent (g/mol)	Feature
		RA-3953	30	PGME	40,000	60	139	350
	RA-4101	25	PGME	30,000	90	200	350	<ul style="list-style-type: none"> • Good heat resistance, chemical resistance • Good developability • Good tack-free property

Molding Grade

Solvent type	Product name	Polymer component (%)	Solvent	Mw	Acid Value of polymer (mgKOH/g)	T _g (°C)	Doublebond equivalent (g/mol)	Feature
		RA-3631P	52	PGMEA	20,000	-	49	250

Hard coat grade

Non-solvent type	Product name	Liquid composition	Mw	Acid Value of polymer (mgKOH/g)	T _g (°C)	Doublebond equivalent (g/mol)	Feature
		AHC-9206AC80	Polymer/DPHA/ACMO =20/60/20	30,000	-	52	250

Adhesive grade

Solvent type	Product name	Polymer component (%)	Solvent	Mw	Acid Value of polymer (mgKOH/g)	T _g (°C)	Doublebond equivalent (g/mol)	Feature
		RA-331P	45	PGMEA /PGME	100,000	70	-42	7,500
Non-solvent type	Product name	Polymer component (%)	Diluent type	Mw	OH Value of polymer (mgKOH/g)	T _g (°C)	Doublebond equivalent (g/mol)	Feature
	RA-341	100	-	80,000	38	-45	13,000	<ul style="list-style-type: none"> • Because it is 100% resin, any blending is possible • Can be designed from slight to strong adhesion by blending • Acid free

※ Mw, T_g is a value at the time of trunk polymer before double bond addition.